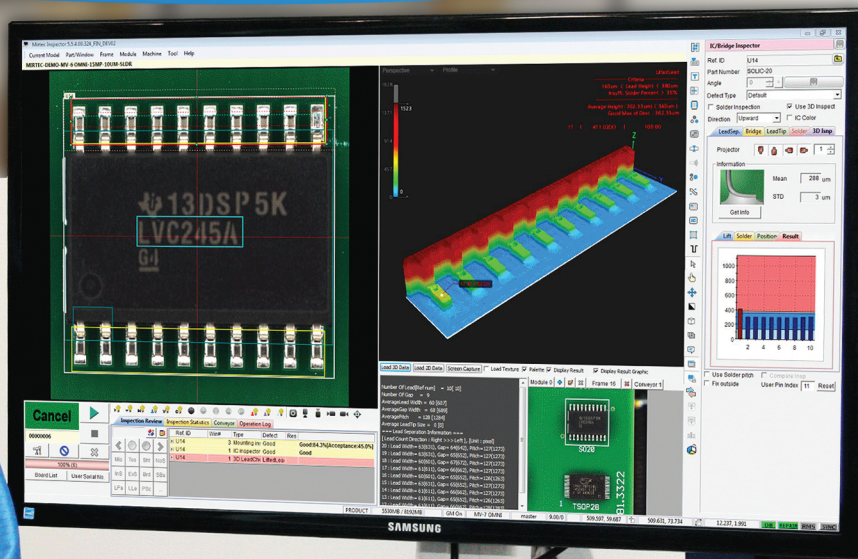
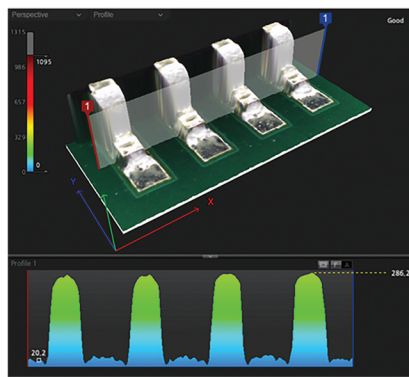
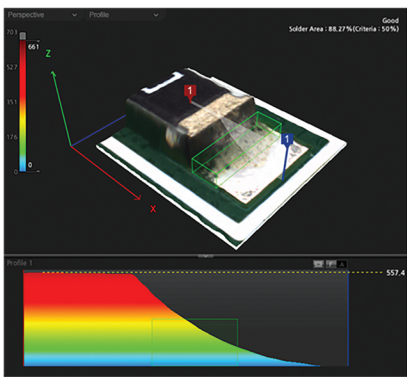


MIRTEC



“CE3 Electronics Inc. is a World-Class Electronics Manufacturing Services provider specializing in advanced printed circuit board assembly and complex cable and wire harness manufacturing. Our company continually invests in state-of-the-art manufacturing equipment to ensure that our clients consistently receive the highest quality PCB assemblies. As part of our commitment to Continuous Quality Improvement, CE3 recently purchased a new MIRTEC MV-6 OMNI 3D AOI machine. I am pleased to report that our operators and inspectors are extremely impressed with the superior performance and accuracy of this system. MIRTEC’s revolutionary OMNI-VISION® 3D Inspection Technology drastically reduces the number of false calls and has enabled us to virtually eliminate visual solder inspection. The comprehensive SPC analysis software is easy to use and provides actionable process information for our quality personnel. CE3 would highly recommend MIRTEC to any company considering the purchase of a 3D AOI machine.” Shawn Aucoin – Engineering Manager



- ▶ OMNI-VISION® 3D Inspection Technology
- ▶ 15 Mega Pixel CoaXPress Camera Technology
- ▶ 10um Telecentric Compound Lens Design
- ▶ 10 Mega Pixel SIDE-VIEWER® Camera System
- ▶ Eight Phase COLOR Lighting System
- ▶ Full 3D Co-Planarity and Solder Fillet Inspection Capability